

Notice of References Cited	Application/Control No. 10/530,478	Applicant(s)/Patent Under Reexamination HIROSE ET AL.	
	Examiner Nabil H. Syed	Art Unit 2612	Page 1 of 1

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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Name	Classification
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*	B	US-6,580,950	06-2003	Johnson et al.	700/17
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*		Document Number Country Code-Number-Kind Code	Date MM-YYYY	Country	Name	Classification
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NON-PATENT DOCUMENTS

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6. Department of Commerce
Patent and Trademark Office

Application No.
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Applicant
Koji HIROSE et al.

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Group
Not Yet Assigned

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DATE CONSIDERED 08/27/2007

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